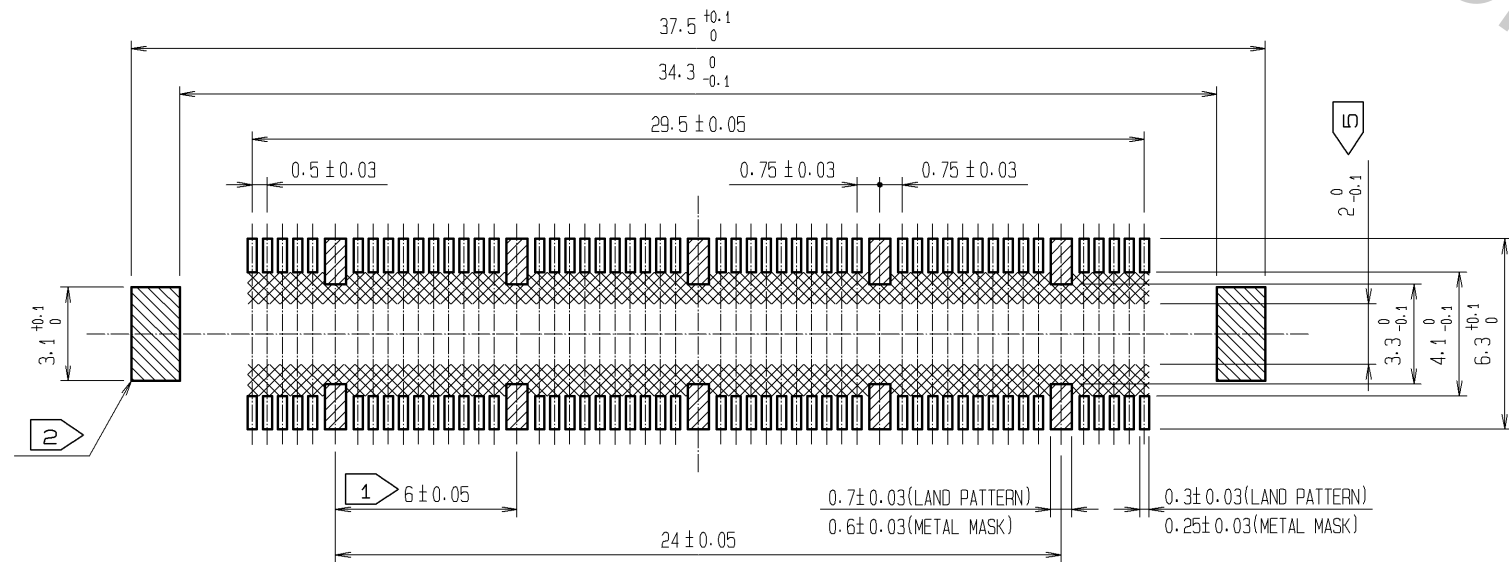


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS : 0.15mm)



- NOTES
- ① 10 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

4	PHOSPHOR BRONZE	TIN-PLATING						
3	PHOSPHOR BRONZE		CONTACT AREA: GOLD 0.1μm min.					
1	LCP	BEIGE UL94V-0	LEAD AREA: TIN-PLATING 1μm min.					
			UNDER PLATING: NICKEL 1μm min.					
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS	
UNITS	mm	SCALE	4 : 1	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
HRS HIROSE ELECTRIC CO., LTD.		APPROVED	HS. OKAWA	08.06.26	DRAWING NO.		EDC3-151965-25	
		CHECKED	HT. YAMAGUCHI	08.06.25	PART NO.		FX10B-100P/10-SV1(71)	
		DESIGNED	SY. KAMIGA	08.06.23	CODE NO.		CL570-0122-0-71	
		DRAWN	HK. SUNADORI	08.06.17			1/1	